

Sensors Unlimited: 640CSX camera



Mil-rugged, high-sensitivity, small-SWaP, InGaAs SWIR camera

The compact Sensors Unlimited Micro-SWIR™ 640CSX is the next-generation SWIR video camera, designed for applications requiring small size, weight and power (SWaP), and available without ITAR restrictions.

BENEFITS

- 640 x 512 pixel format, 12.5 μm pitch
- 30 or 60 frames per second full frame rate
- 1.5 W power consumption (@ +20°C)
- High-sensitivity 0.9 to 1.7 μm spectrum response imager; NIR/SWIR from 0.7 to 1.7 μm
- Low-light to daytime imaging
- Compact size
- All solid-state InGaAs imager
- Snapshot exposure
- On-board, real-time non-uniformity corrections
- Digital 12-bit Camera Link® base output
- Automatic gain control (AGC)
- C-mount compatible; adapters available
- User-defined region of interest (ROI) windowing mode
- Tested to MIL-STD-810G for functional shock, vibration, thermal shock, storage temperature and humidity
- Operates from -40°C to +70°C case temperature

The Sensors Unlimited Micro-SWIR 640CSX features a 640 x 512 pixel, high-sensitivity, stabilized InGaAs snapshot imager and uses our advanced image enhancement algorithms to produce the highest-quality imagery in all lighting conditions.

The camera provides real-time daylight to low-light imaging in the short wave infrared (SWIR) wavelength spectrum for a range of applications that include industrial process monitoring, enhanced vision and persistent surveillance. On-board automatic gain control (AGC) optimizes the camera's dynamic response throughout day and night imaging scenarios. Camera Link® digital output provides for plug-and-play video with 12-bit images for digital image output.

The light weight, compact size and low power draw are ideally suited for integration into commercial systems and industrial process monitoring applications. Optional NIR/SWIR technology is available to extend the sensitivity of the 640CSX below 0.9 μm , offering the advantage of both near infrared (NIR) and short wave infrared wavelength response.

Applications

- Low-light level imaging
- Covert surveillance
- Multi-laser spotting and tracking
- Imaging through atmospheric obscurants
- Small size facilitates integration into unmanned aerial vehicles (UAVs), handheld and soldier-mounted systems
- Industrial processing monitoring
- Enhanced Vision Systems (EVS)
- Silicon wafer or integrated circuit microscopy

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| Mechanical specifications | | Environmental and power specifications | |
|--|---|---|---|
| Model | SU640CSX-12.5B-ENC housed series SU640CSX-12.5B-OEM | Operating case temperature | -40°C to +70°C |
| Dimensions (width x height x depth) (includes connectors, excludes lens mm) | Enclosed: 1.25"W x 1.25"H x 1.21"D 31.8 x 31.8 x 30.7 mm OEM: 1.25"W x 1.25"H x 1.21"D 31.8 x 31.8 x 30.7 mm | Storage temperature | -54°C to +85°C |
| Weight | ENC Series: ≤45 grams OEM Series: ≤41 grams | Humidity | 95% relative humidity – non-condensing |
| Lens mount | C-mount | Power requirements: AC adapter supplied DC voltage power | DC voltage: +4.5-16V Power: 1.5 W at +20°C case temperature, maximum <4.25 W |
| Camera link connector | 26-pin SDR standard connector Board-to-board connector option for OEM model | Functional shock, random vibration, and thermal shock | Tested to MIL-STD-810G for functional shock, vibration, thermal shock, storage temperature and humidity |
| Power input connector | 14-pin SDR standard connector | | |
| Pixel pitch | 12.5 μm | | |
| Focal plane array format | 640 x 512 pixels | | |
| Active area | 8.0 mm x 6.4 mm x 10.2 mm diagonal | | |

Specifications subject to change without notice.



| Electrical specifications | | |
|--|--|--|
| | 30 fps | 60 fps |
| Optical fill factor | 100 % | 100 % |
| Spectral response | Standard, 0.9 μm to 1.7 μm NIR/SWIR, 0.7 μm to 1.7 μm | Standard, 0.9 μm to 1.7 μm NIR/SWIR, 0.7 μm to 1.7 μm |
| Quantum efficiency | Standard, > 65% from 1 μm to 1.6 μm NIR/SWIR, > 65% from 0.9 μm to 1.6 μm | Standard, > 65% from 1 μm to 1.6 μm NIR/SWIR, > 65% from 0.9 μm to 1.6 μm |
| Mean detectivity, D*¹ | > 2.5 x 10 ¹³ cm√Hz/W (typical) | > 2.8 x 10 ¹³ cm√Hz/W (typical) |
| Noise equivalent irradiance¹ | < 9.7 x 10 ⁸ photons/cm ² /s (typical) | < 1.2 x 10 ⁹ photons/cm ² /s (typical) |
| Noise (RMS)¹ | < 35 electrons (typical) | < 25 electrons (typical) |
| Dynamic range¹ | > 2500:1 at low gain > 800:1 at high gain | > 2500:1 at low gain > 1100:1 at high gain |
| Operability² | > 99 % | > 99 % |
| Exposure times, preconfigured | 200 μs to 32 ms | 200 μs to 32 ms |
| Image correction | Two point (offset and gain) pixel by pixel, user selectable | Two point (offset and gain) pixel by pixel, user selectable |
| Output format | 12-bit base Camera Link® | 12-bit base Camera Link® |
| Digital output frame rate | 30 fps | 60 fps |
| Scan mode | Continuous | Continuous |



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¹ Typical, λ = 1550 nm, exposure time = 33 ms (30FPS) / 16.67 ms (60FPS), case temperature = 20°C, highest sensitivity gain setting, no lens, corrections off, 1x digital gain, with AGC, enhancement and correction off.
² The percentage of pixels with responsivity deviation less than 35% from the mean.

